

2N5551

MMBT5551





NPN General Purpose Amplifier

This device is designed for general purpose high voltage amplifiers and gas discharge display drivers.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	160	V
V _{CBO}	Collector-Base Voltage	180	V
V _{EBO}	Emitter-Base Voltage	6.0	V
Ic	Collector Current - Continuous	600	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	М	Units	
		2N5551	*MMBT5551	
P _D	Total Device Dissipation	625	350	mW
	Derate above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

NPN General Purpose Amplifier

6.0

20

250

8.0

50

pF pF

dΒ

(continued)

Symbol	Parameter	Test Conditions	Min	Max	Units	
OFF CHAI	RACTERISTICS					
$V_{(BR)CEO}$	Collector-Emitter Sustaining Voltage*	$I_C = 1.0 \text{ mA}, I_B = 0$	160		V	
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	180		V	
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	6.0		V	
I _{CBO}	Collector Cutoff Current	$V_{CB} = 120 \text{ V}, I_E = 0,$ $V_{CB} = 120 \text{ V}, I_E = 0, T_A = 100^{\circ}\text{C}$		50 50	nA μA	
I _{EBO}	Emitter Cutoff Current	$V_{EB} = 4.0 \text{ V}, I_{C} = 0$		50	nA	
ON CHAR	ACTERISTICS DC Current Gain	I _C = 1.0 mA, V _{CE} = 5.0 V	80			
		$I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V}$ $I_C = 50 \text{ mA}, V_{CE} = 5.0 \text{ V}$	80 30	250		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 50 \text{ mA}, V_C = 0.0 \text{ V}$ $I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$		0.15 0.20	V V	
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA}$ $I_C = 50 \text{ mA}, I_B = 5.0 \text{ mA}$		1.0 1.0	V V	
SMALL SI	GNAL CHARACTERISTICS					
f _T	Current Gain - Bandwidth Product	$I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V},$ f = 100 MHz	100	300	MHz	

Noise Figure

Output Capacitance

Small-Signal Current Gain

Input Capacitance

Spice Model

 C_{obo}

Cibo

 h_{fe}

NF

 $NPN \ (Is=2.511f \ Xti=3 \ Eg=1.11 \ Vaf=100 \ Bf=242.6 \ Ne=1.249 \ Is=2.511f \ Ikf=.3458 \ Xtb=1.5 \ Br=3.197 \ Nc=2 \ Isc=0 \ Ikr=0 \ Rc=1 \ Cjc=4.883p \ Mjc=.3047 \ Vjc=.75 \ Fc=.5 \ Cje=18.79p \ Mje=.3416 \ Vje=.75 \ Tr=1.202n \ Tf=560p \ Itf=50m \ Vtf=5 \ Xtf=8 \ Rb=10)$

 $V_{CB} = 10 \text{ V}, I_{E} = 0,$ f = 1.0 MHz

 $V_{BE} = 0.5 \text{ V}, I_{C} = 0,$

 $I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V},$

 I_C = 250 μA, V_{CE} = 5.0 V, R_S =1.0 kΩ, f=10 Hz to 15.7 kHz

f = 1.0 MHz

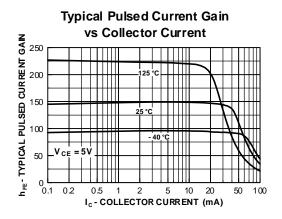
f = 1.0 kHz

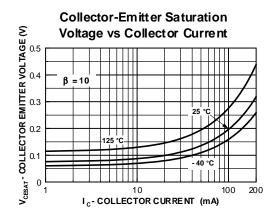
^{*}Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

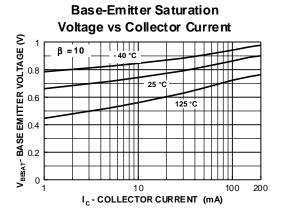
NPN General Purpose Amplifier

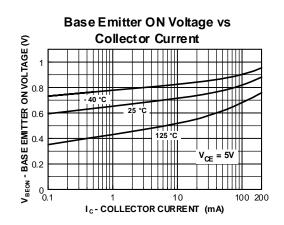
(continued)

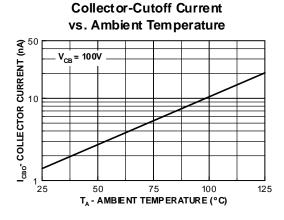
Typical Characteristics

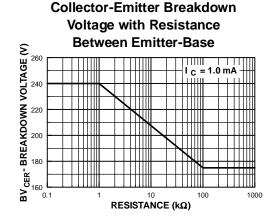










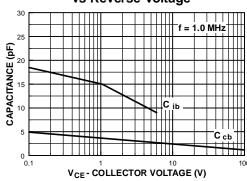


NPN General Purpose Amplifier

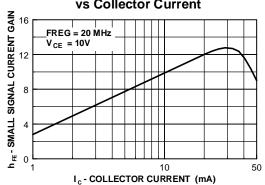
(continued)

Typical Characteristics (continued)

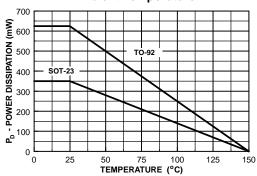
Input and Output Capacitance vs Reverse Voltage



Small Signal Current Gain vs Collector Current



Power Dissipation vs Ambient Temperature

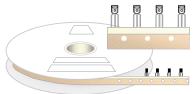


TO-92 Tape and Reel Data FAIRCHILD SEMICONDUCTOR TM **TO-92 Packaging** Configuration: Figure 1.0 **TAPE and REEL OPTION** FSCINT Label sample See Fig 2.0 for various Reeling Styles CBVK//418019 **FSCINT** Label 5 Reels per Intermediate Box Customized F63TNR Label sample Label F63TNR LOT: CBVK741B019 QTY: 2000 FSID: PN222N Customized QTY1: QTY2: Label 375mm x 267mm x 375mm Intermediate Box TO-92 TNR/AMMO PACKING INFROMATION **AMMO PACK OPTION** See Fig 3.0 for 2 Ammo Packing Style Quantity EOL code **Pack Options** 2,000 D26Z Е 2,000 D27Z Ammo М 2,000 D74Z D75Z 2,000 **FSCINT** Unit weight = 0.22 gm Reel weight with components = 1.04 kg Ammo weight with components = 1.02 kg Max quantity per intermediate box = 10,000 units Label 5 Ammo boxes per Intermediate Box 327mm x 158mm x 135mm Immediate Box Customized F63TNR Customized Label Label 333mm x 231mm x 183mm Intermediate Box (TO-92) BULK PACKING INFORMATION **BULK OPTION** See Bulk Packing DESCRIPTION QUANTITY Information table J18Z TO-18 OPTION STD 2.0 K / BOX Anti-static Bubble Sheets TO-5 OPTION STD NO LEAD CLIP 1.5 K / BOX J05Z **FSCINT Label** NO EOL TO-92 STANDARD STRAIGHT FOR: PKG 92, NO LEADCLIP 2.0 K / BOX 94 (NON PROELECTRON SERIES), 96 TO-92 STANDARD STRAIGHT FOR: PKG 94 (PROELECTRON SERIES BCXXX, BFXXX, BSRXXX), 97, 98 L34Z NO LEADCLIP 2.0 K / BOX 2000 units per 114mm x 102mm x 51mm EO70 box for std option Immediate Box 5 EO70 boxes per intermediate Box 530mm x 130mm x 83mm Customized Intermediate box Label FSCINT Label 10,000 units maximum per intermediate box for std option

TO-92 Tape and Reel Data, continued

TO-92 Reeling Style Configuration: Figure 2.0

Machine Option "A" (H)

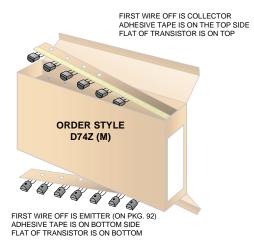


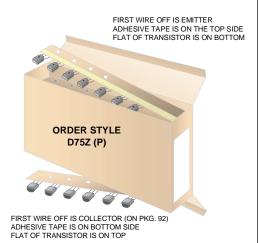
Style "A", D26Z, D70Z (s/h)

Machine Option "E" (J)

Style "E", D27Z, D71Z (s/h)

TO-92 Radial Ammo Packaging Configuration: Figure 3.0



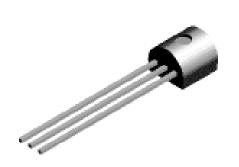


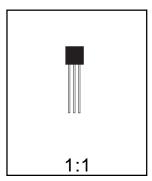


TO-92 Package Dimensions



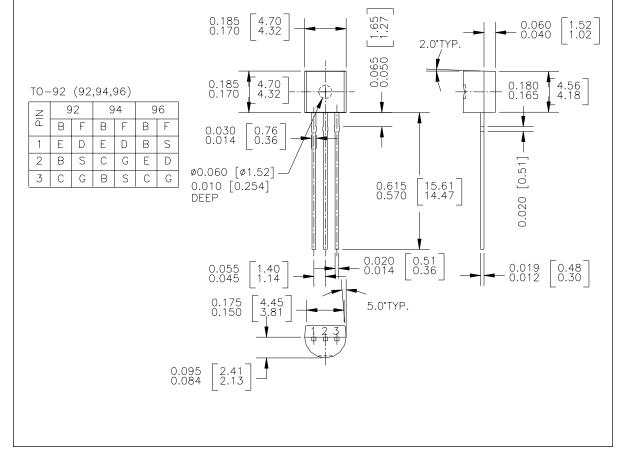
TO-92 (FS PKG Code 92, 94, 96)

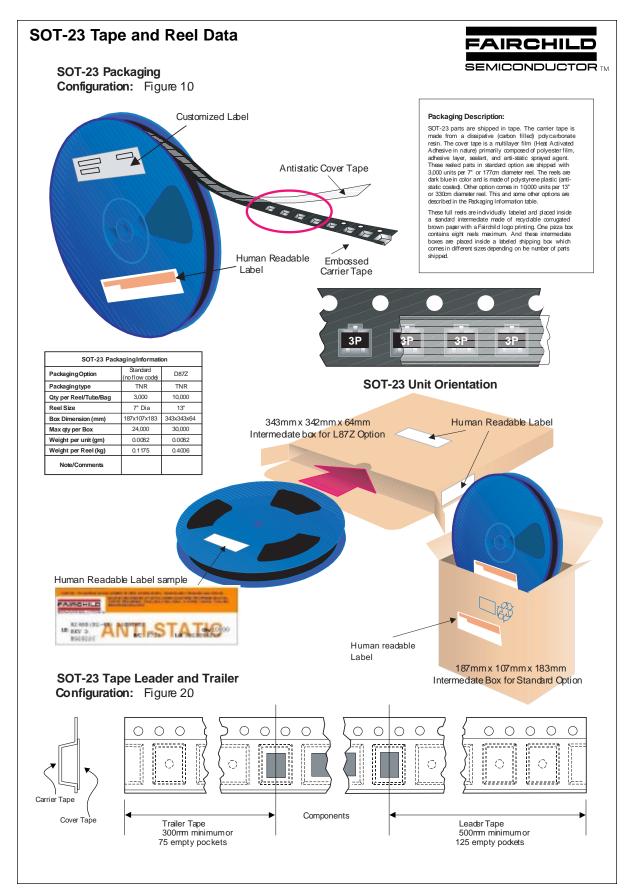




Scale 1:1 on letter size paper
Dimensions shown below are in:
inches [millimeters]

Part Weight per unit (gram): 0.1977

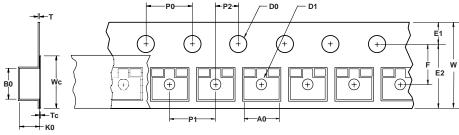




SOT-23 Tape and Reel Data, continued

SOT-23 Embossed Carrier Tape

Configuration: Figure 3.0



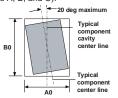
User Direction of Feed

	Dimensions are in millimeter													
Pkg type	Pkg type A0 B0 W D0 D1 E1 E2 F P1 P0 K0 T Wc Tc													
SOT-23 (8mm)	3.15 +/-0.10	2.77 +/-0.10	8.0 +/-0.3	1.55 +/-0.05	1.125 +/-0.125	1.75 +/-0.10	6.25 min	3.50 +/-0.05	4.0 +/-0.1	4.0 +/-0.1	1.30 +/-0.10	0.228 +/-0.013	5.2 +/-0.3	0.06 +/-0.02

Notes: A0, B0, and K0 dimensions are determined with respect to the EIA/Jedec RS-481 rotational and lateral movement requirements (see sketches A, B, and C).



Sketch A (Side or Front Sectional View)
Component Rotation

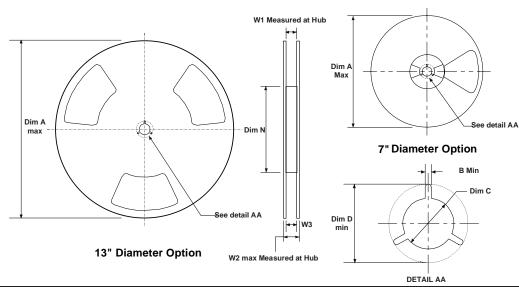


Sketch B (Top View)
Component Rotation



Sketch C (Top View)
Component lateral movement

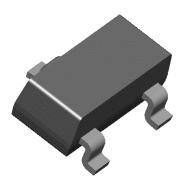
SOT-23 Reel Configuration: Figure 4.0

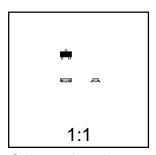


	Dimensions are in inches and millimeters										
Tape Size Reel Option Dim A Dim B Dim C Dim D Dim N Dim W1 Dim W2 Dim W3 (LSL-US											
8mm	7" Dia	7.00 177.8	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	2.165 55	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9		
8mm	13" Dia	13.00 330	0.059 1.5	512 +0.020/-0.008 13 +0.5/-0.2	0.795 20.2	4.00 100	0.331 +0.059/-0.000 8.4 +1.5/0	0.567 14.4	0.311 - 0.429 7.9 - 10.9		



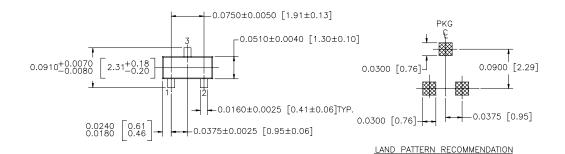
SOT-23 (FS PKG Code 49)

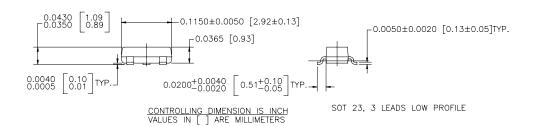




Scale 1:1 on letter size paper Dimensions shown below are in:

inches [millimeters]
Part Weight per unit (gram): 0.0082





NOTE: UNLESS OTHERWISE SPECIFIED

- 1. STANDARD LEAD FINISH 150 MICROINCHES / 3.81 MICROMETERS MINIMUM TIN / LEAD (SOLDER) ON ALLOY 42
- 2. REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE G, DATED JUL 1993

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DOME™ ISOPLANAR™ Quiet Series™

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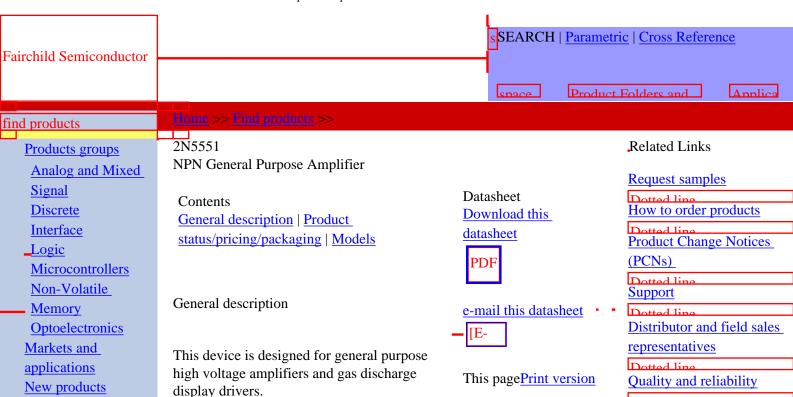
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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition					
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.					
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.					
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back to top

Product selection and

<u>parametric search</u> <u>Cross-reference</u>

technical information

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Package marking	Packing method
2N5551CTA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551BU	Full Production	\$0.053	<u>TO-92</u>	3	N/A	BULK
2N5551YCHBU	Full Production	\$0.053	<u>TO-92</u>	3	N/A	BULK
2N5551YIUBU	Full Production	\$0.053	<u>TO-92</u>	3	N/A	BULK
2N5551YTA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551TA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551CBU	Full Production	\$0.053	<u>TO-92</u>	3	N/A	BULK
2N5551IUTA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551	Full Production	\$0.085	TO-92	3	\$Y&3 2N 5551	BULK
2N5551CYTA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551YBU	Full Production	\$0.053	<u>TO-92</u>	3	N/A	BULK
2N5551TF	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL
2N5551YIUTA	Full Production	\$0.053	<u>TO-92</u>	3	N/A	TAPE REEL

Design tools

back to top

^{* 1,000} piece Budgetary Pricing

Models

Package & leads	Condition	Temperature range	Software version	Revision date
PSPICE				
TO-92-3	Electrical	25°C	N/A	N/A

back to top

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